502753446 04/04/2014

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT2800042

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
RYUJI IKEDA	03/14/2014

### **RECEIVING PARTY DATA**

Name:	SMK CORPORATION
Street Address:	5-5, Togoshi 6-chome
Internal Address:	Shinagawa-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	142-8511

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14242887

#### **CORRESPONDENCE DATA**

**Fax Number:** (000)000-0000

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

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NAME OF SUBMITTER:	ADAM S. LANGLEY	
SIGNATURE:	/Adam S. Langley/	
DATE SIGNED:	04/04/2014	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

**Total Attachments: 1** 

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PATENT 502753446 REEL: 032599 FRAME: 0845

# COMBINED DECLARATION (37 CFR §1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR §1.76) AND ASSIGNMENT-

As the below named inventor, I hereby declare that:

This declaration is directed to:
The attached application, or
United States application or PCT international application No. filed on .
The above-identified application was made or was authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.
WHEREAS I, the undersigned inventor, hereafter also referred to as "assignor", have invented certain new and useful improvements described in the above identified application; and
WHEREAS, SMK Corporation hereinafter also referred to as "assignee", whose address is 5–5, Togoshi 6-chome, Shinagawa-ku, Tokyo 142-8511 JAPAN, is desirous of acquiring the entire right, title and interest in and to the application and invention, and to any United States patents to be obtained therefor;
NOW, THEREFORE, for valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title, and interest in the application and the invention disclosed therein for the United States of America, including all divisions and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including any right to bring or maintain an action for infringement under the provisional rights granted pursuant to Title 35, Section 154 of the United States Code or any other cause of action for acts which would constitute infringement occurring prior to this assignment, and including the right to claim priority under the International Conventions of Paris (1883), as amended, of or in any corresponding foreign patent application, and I request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns.

PATENT REEL: 032599 FRAME: 0846

2014/3/14

Date

RECORDED: 04/04/2014

Ryuji IKEDA

袒田能

Legal Name of Inventor

Inventor's Signature